EVERLIGHT ELECTRONICS CO.,LTD.

Technical Data Sheet

Chip LED with Bi-Color (Multi-Color)

15-22/R6G6C-A32/2T

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Multi-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Descriptions

- The 15-22 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

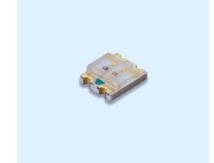
Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

Chip		E . W. I C. I.	Dasin Calan	
Туре	Material	Emitted Color	Resin Color	
R6	AlGaInP	Brilliant Red	Water Class	
G6	AlGaInP	Brilliant Yellow Green	Water Clear	

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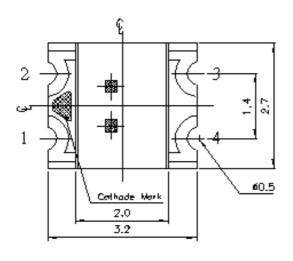
Device No:DSE-0000333 Prepared date: 31-Oct-2008

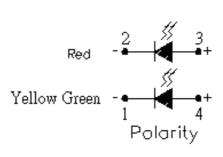
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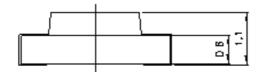
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15-22/R6G6C-A32/2T

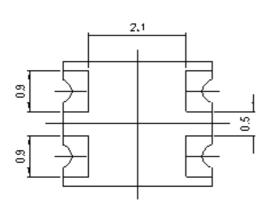
Package Outline Dimensions

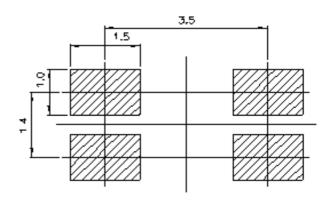






For Reflow Sodering





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Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	${ m I}_{ m F}$	R6:25	mA	
Forward Current		G6:25	IIIA	
Peak Forward Current	Ifp	R6:60	mA	
(Duty 1/10 @1KHz)	IFP	G6:60	IIIA	
Dower Dissination	Pd	R6:60	mW	
Power Dissipation		G6:60	mw	
Electrostatic Discharge (UDM)	ESD	R6:2000	V	
Electrostatic Discharge(HBM)		G6:2000	V	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}$ C	
Storage Temperature	Tstg	-40~ +90	$^{\circ}\!\mathbb{C}$	
0.11 : T	T. 1	Reflow Soldering : 260 ℃ for 10 sec.		
Soldering Temperature	Tsol	Hand Soldering : 350 °C for 3 sec.		

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Electro-Optical Characteristics (Ta=25°C)

Parameter	Sym	ıbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	R6 G6	28.5 28.5		72.0 72.0	mcd	
Viewing Angle	$2\theta_{1/2}$			140		deg	
Peak Wavelength	$\lambda_{ m p}$	R6 G6		632 575		nm	
Dominant Wavelength	$\lambda_{ m d}$	R6 G6	617.5 567.5		633.5 577.5	nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ	R6 G6		20 20		nm	
Forward Voltage	V_{F}	R6 G6	1.7 1.7	2.0	2.4 2.4	V	
Reverse Current	I_R	R6 G6			10 10	μΑ	V _R =5V

Notes:

- 1.Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm

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Bin Range Of Luminous Intensity

R6

Bin	Min	Max	Unit	Condition
N	28.5	45.0	mcd	T 20 A
P	45.0	72.0		$I_F = 20 \text{mA}$

G6

Bin	Min	Max	Unit	Condition
N	28.5	45.0	mcd	I _F =20mA
P	45.0	72.0		

Notes:

1. Tolerance of Luminous Intensity $\pm 11\%$

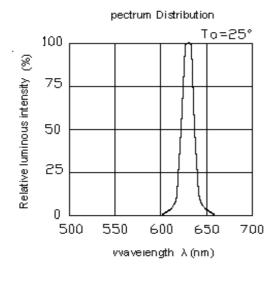
Everlight Electronics Co., Ltd. Device No:DSE-0000333

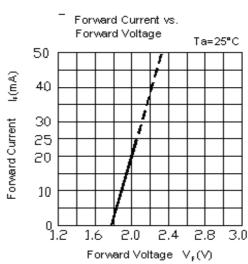
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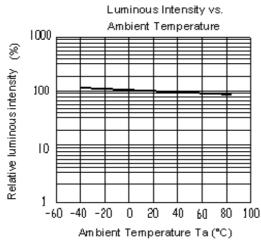
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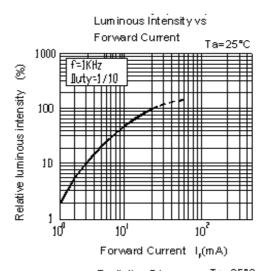
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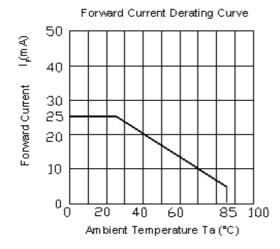
Typical Electro-Optical Characteristics Curves R6

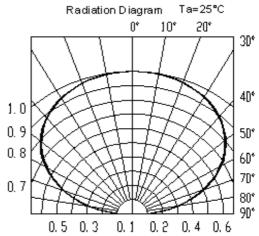




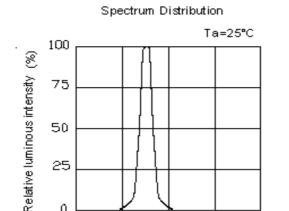








Typical Electro-Optical Characteristics Curves G6



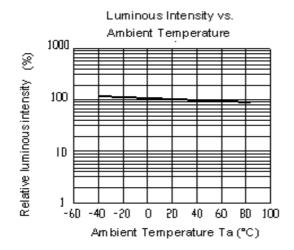
500

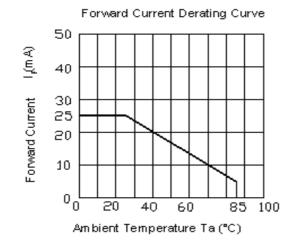
550

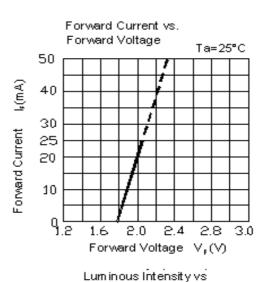
600

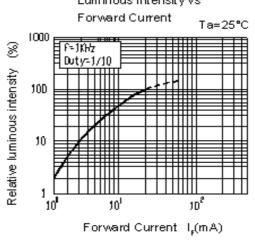
Wavelength λ (nm)

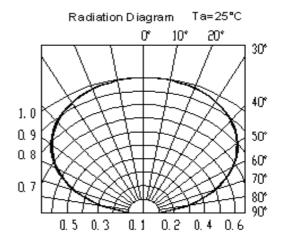
650











700

Label explanation

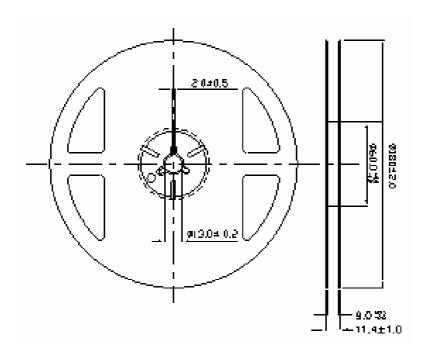
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank

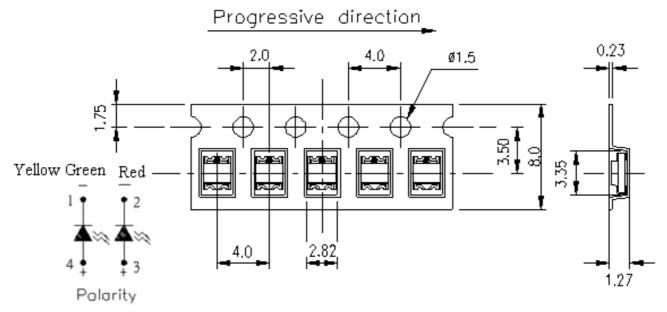


Reel Dimensions



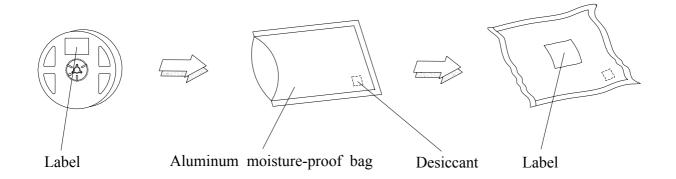
Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: Tolerances Unless Dimension ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H:+100°C 15min ∫ 5 min L:-40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

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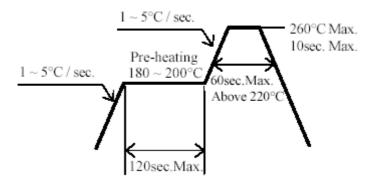
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Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment : $60\pm5^{\circ}$ C for 24 hours.
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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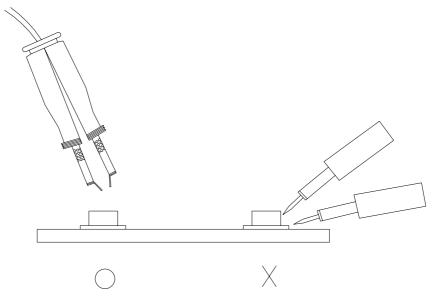


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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